



DRV5057 Linear Hall Effect Sensor With PWM Output

1 Features

- PWM-Output Linear Hall Effect Magnetic Sensor
- Operates From 3.3-V and 5-V Power Supplies
- 2-kHz Clock Output With 50% Quiescent Duty Cycle
- Magnetic Sensitivity Options (At $V_{CC} = 5\text{ V}$):
 - A1: 2%D/mT, $\pm 21\text{-mT}$ Range
 - A2: 1%D/mT, $\pm 42\text{-mT}$ Range
 - A3: 0.5%D/mT, $\pm 84\text{-mT}$ Range
 - A4: 0.25%D/mT, $\pm 168\text{-mT}$ Range
- Open-Drain Output With 20-mA Sink Capability
- Compensation for Magnet Temperature Drift
- Standard Industry Packages:
 - Surface-Mount SOT-23
 - Through-Hole TO-92

2 Applications

- Precise Position Sensing
- Industrial Automation and Robotics
- Home Appliances
- Gamepads, Pedals, Keyboards, Triggers
- Height Leveling, Tilt and Weight Measurement
- Fluid Flow Rate Measurement
- Medical Devices
- Absolute Angle Encoding
- Current Sensing

3 Description

The DRV5057 is a linear Hall effect sensor that responds proportionally to magnetic flux density. The device can be used for accurate position sensing in a wide range of applications.

The device operates from 3.3-V or 5-V power supplies. When no magnetic field is present, the output produces a clock with a 50% duty cycle. The output duty cycle changes linearly with the applied magnetic flux density, and four sensitivity options maximize the output dynamic range based on the required sensing range. North and south magnetic poles produce unique outputs. The typical pulse-width modulation (PWM) carrier frequency is 2 kHz.

Magnetic flux perpendicular to the top of the package is sensed, and the two package options provide different sensing directions.

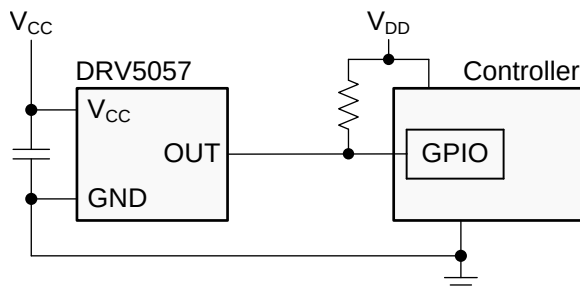
Because the PWM signal is based on edge-to-edge timing, signal integrity is maintained in the presence of voltage noise or ground potential mismatch. This signal is suitable for distance transmission in noisy environments, and the always-present clock allows the system controller to confirm there are good interconnects. Additionally, the device features magnet temperature compensation to counteract how magnets drift for linear performance across a wide -40°C to $+125^{\circ}\text{C}$ temperature range.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)
DRV5057	SOT-23 (3)	2.92 mm × 1.30 mm
	TO-92 (3)	4.00 mm × 3.15 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Typical Schematic



Magnetic Response (A1, A2, A3, A4 Versions)

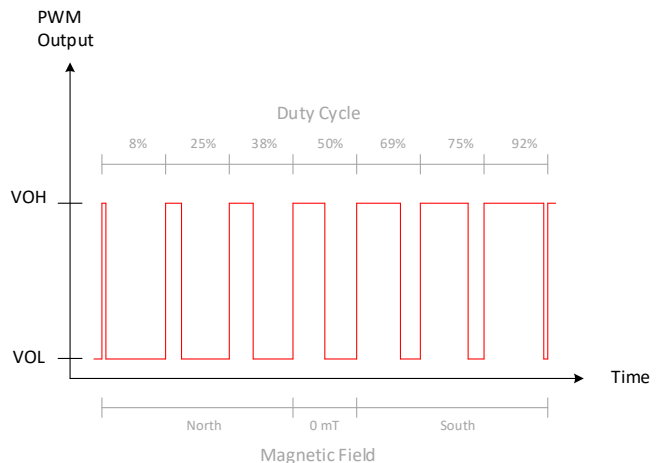


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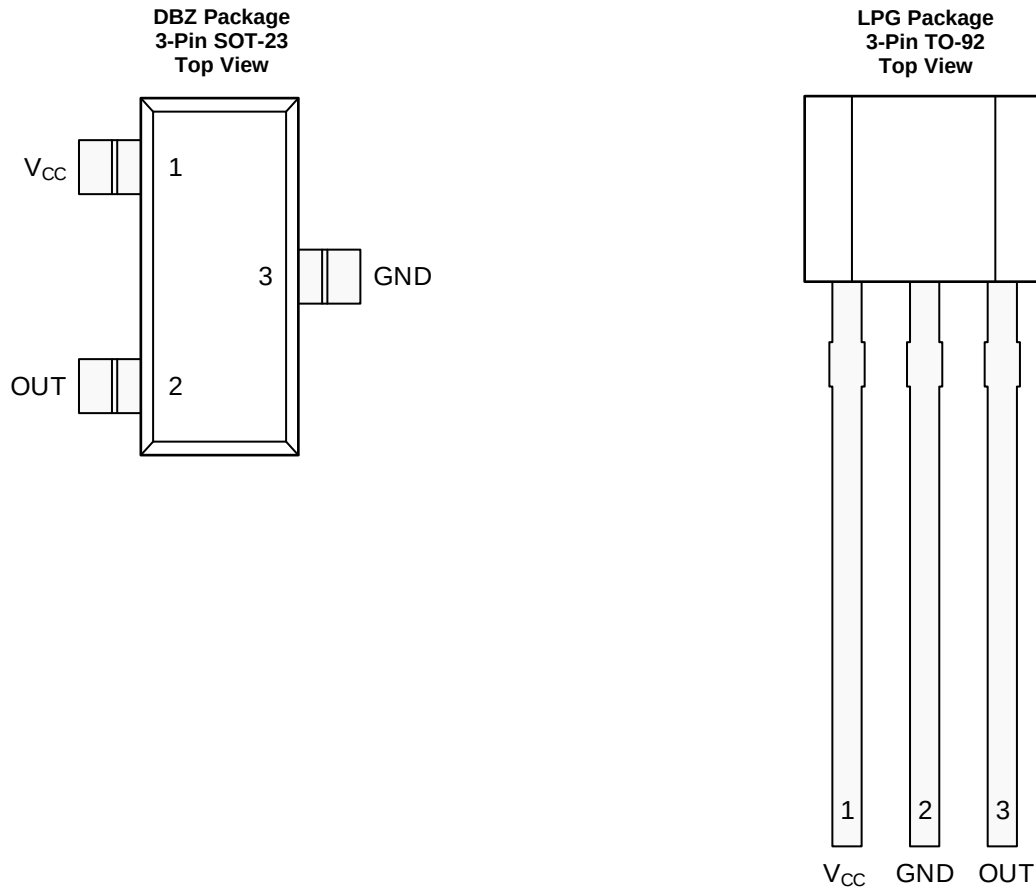
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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

DATE	REVISION	NOTES
November 2018	*	Initial release.

5 Pin Configuration and Functions



Pin Functions

PIN			I/O	DESCRIPTION
NAME	SOT-23	TO-92		
V _{CC}	1	1	—	Power supply. TI recommends connecting this pin to a ceramic capacitor to ground with a value of at least 0.01 μ F.
OUT	2	3	O	Analog output
GND	3	2	—	Ground reference

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
Power supply voltage	V _{CC}	–0.3	7	V
Output voltage	OUT	–0.3	6	V
Output current	OUT		30	mA
Magnetic flux density, B _{MAX}		Unlimited		T
Operating junction temperature, T _J		–40	150	°C
Storage temperature, T _{stg}		–65	150	°C

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±3000	V
		Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	±750	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V_{CC}	Power-supply voltage ⁽¹⁾	3	3.63	V
		4.5	5.5	
V_O	Output pullup voltage	0	5.5	V
I_O	Output continuous current	0	20	mA
T_A	Operating ambient temperature ⁽²⁾	–40	125	°C

(1) There are two isolated operating V_{CC} ranges. For more information see the [Operating \$V_{CC}\$ Ranges](#) section.

(2) Power dissipation and thermal limits must be observed.

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾		DRV5057		UNIT
		SOT-23 (DBZ)	TO-92 (LPG)	
		3 PINS	3 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	170	121	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	66	67	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	49	97	°C/W
Y_{JT}	Junction-to-top characterization parameter	1.7	7.6	°C/W
Y_{JB}	Junction-to-board characterization parameter	48	97	°C/W

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics application report](#).

6.5 Electrical Characteristics

for $V_{CC} = 3\text{ V}$ to 3.63 V and 4.5 V to 5.5 V , over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS ⁽¹⁾	MIN	TYP	MAX	UNIT
I_{CC}	Operating supply current			6	10	mA
t_{ON}	Power-on time (see Figure 15)	$B = 0\text{ mT}$, no load on OUT		0.6	0.9	ms
f_{PWM}	PWM carrier frequency		1.8	2.0	2.2	kHz
D_J	Duty cycle peak-to-peak jitter	From change in B to change in OUT		±0.1		%D ⁽¹⁾
I_{OZ}	High-impedance output leakage current	$V_{CC} = 5\text{ V}$			100	nA
V_{OL}	Low-level output voltage	$I_{OUT} = 20\text{ mA}$		0.15	0.4	V

(1) This unit is a percentage of duty cycle.

6.6 Magnetic Characteristics

for $V_{CC} = 3\text{ V}$ to 3.63 V and 4.5 V to 5.5 V , over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS ⁽¹⁾		MIN	TYP	MAX	UNIT
D _L	Linear duty cycle range			8		92	%D
D _{CL}	Clamped-low duty cycle	B < −250 mT		5.3	6	6.7	%D
D _{CH}	Clamped-high duty cycle	B > 250 mT		93.3	94	94.7	
D _Q	Quiescent duty cycle ⁽²⁾	B = 0 mT, T _A = 25°C, V _{CC} = 3.3 V or 5 V		46	50	54	%D
V _{QAL}	Quiescent voltage lifetime drift	High-temperature operating stress for 1000 hours		<0.5			%
S	Sensitivity	V _{CC} = 5 V, T _A = 25°C	DRV5057A1	1.88	2	2.12	%D/ mT
			DRV5057A2	0.94	1	1.06	
			DRV5057A3	0.47	0.5	0.53	
			DRV5057A4	0.23	0.25	0.27	
		V _{CC} = 3.3 V, T _A = 25°C	DRV5057A1	1.13	1.2	1.27	
			DRV5057A2	0.56	0.6	0.64	
			DRV5057A3	0.28	0.3	0.32	
			DRV5057A4	0.138	0.15	0.162	
B _L	Linear magnetic sensing range ⁽³⁾ (4)	V _{CC} = 5 V, T _A = 25°C	DRV5057A1	±21			mT
			DRV5057A2	±42			
			DRV5057A3	±84			
			DRV5057A4	±168			
S _{TC}	Sensitivity temperature compensation for magnets ⁽⁵⁾			0.12			%/°C
S _{LE}	Sensitivity linearity error ⁽⁴⁾	Output duty cycle is within D _L		±1			%
R _{SE}	Sensitivity error over operating VCC range	Output duty cycle is within D _L		±1			%
S _{ΔL}	Quiescent error over operating VCC range			<0.5%			%

(1) B is the applied magnetic flux density.

(2) See the section.

(3) B_L describes the minimum linear sensing range at 25°C taking into account the maximum V_Q and Sensitivity tolerances.

(4) See the [Sensitivity Linearity](#) section.

(5) S_{TC} describes the rate the device increases Sensitivity with temperature. For more information, see the [Sensitivity Temperature Compensation for Magnets](#) section and [Figure 4](#) to [Figure 11](#).

6.7 Typical Characteristics

for $T_A = 25^\circ\text{C}$ (unless otherwise noted)

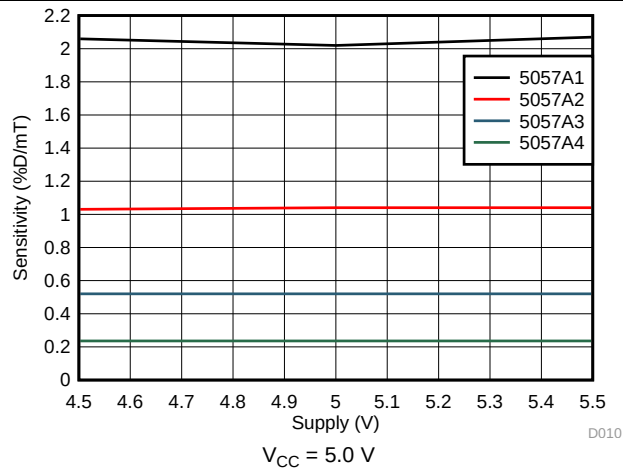


Figure 1. Sensitivity vs Supply Voltage

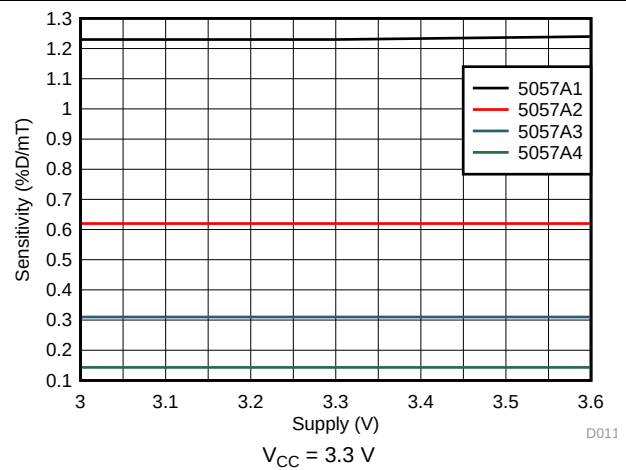


Figure 2. Sensitivity vs Supply Voltage

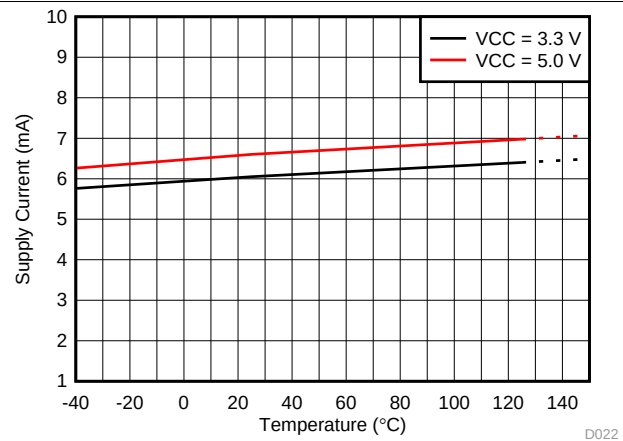


Figure 3. Supply Current vs Temperature

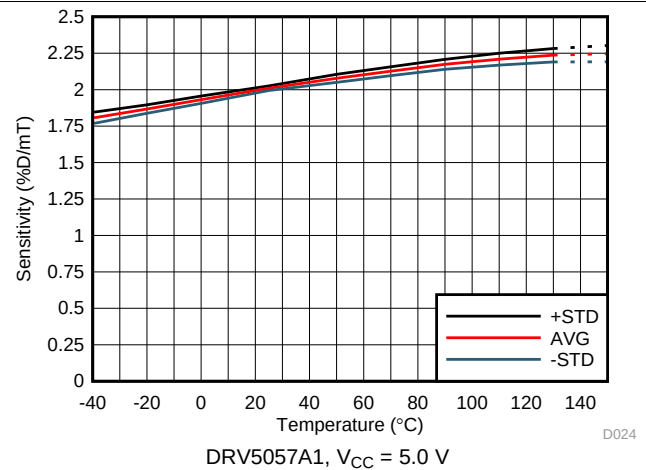


Figure 4. Sensitivity vs Temperature

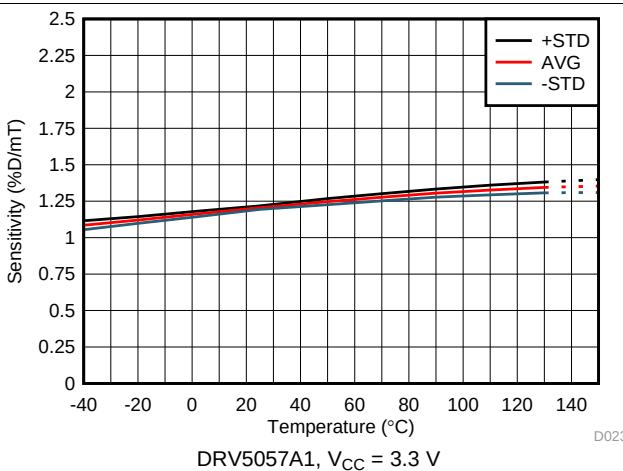


Figure 5. Sensitivity vs Temperature

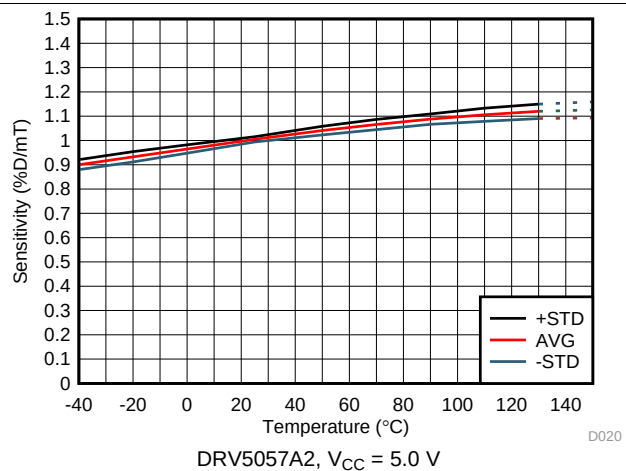


Figure 6. Sensitivity vs Temperature

Typical Characteristics (continued)

for $T_A = 25^\circ\text{C}$ (unless otherwise noted)

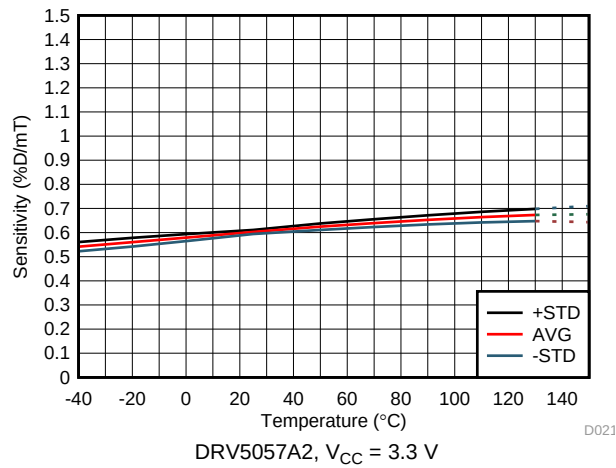


Figure 7. Sensitivity vs Temperature

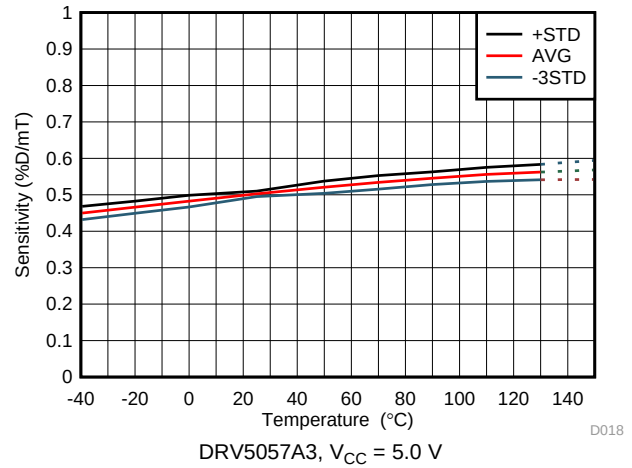


Figure 8. Sensitivity vs Temperature

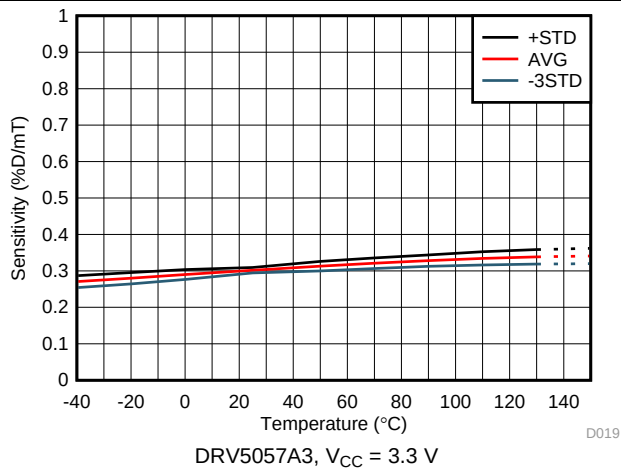


Figure 9. Sensitivity vs Temperature

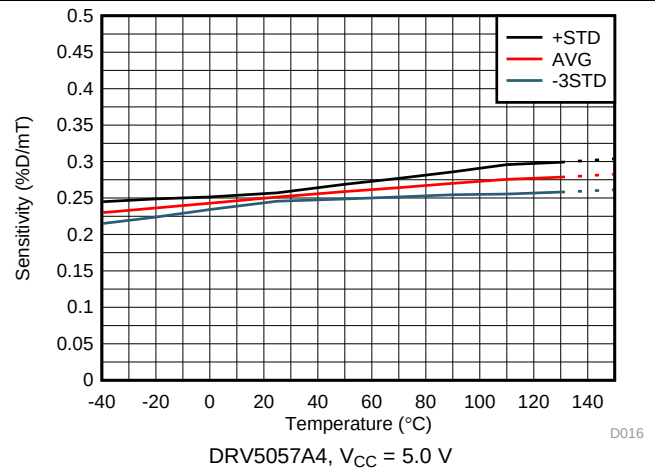


Figure 10. Sensitivity vs Temperature

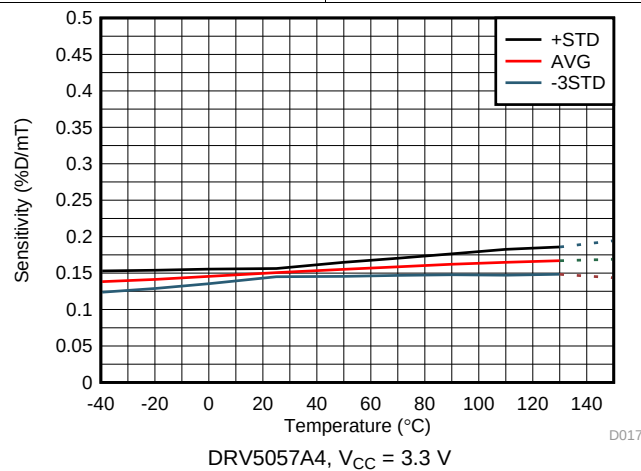


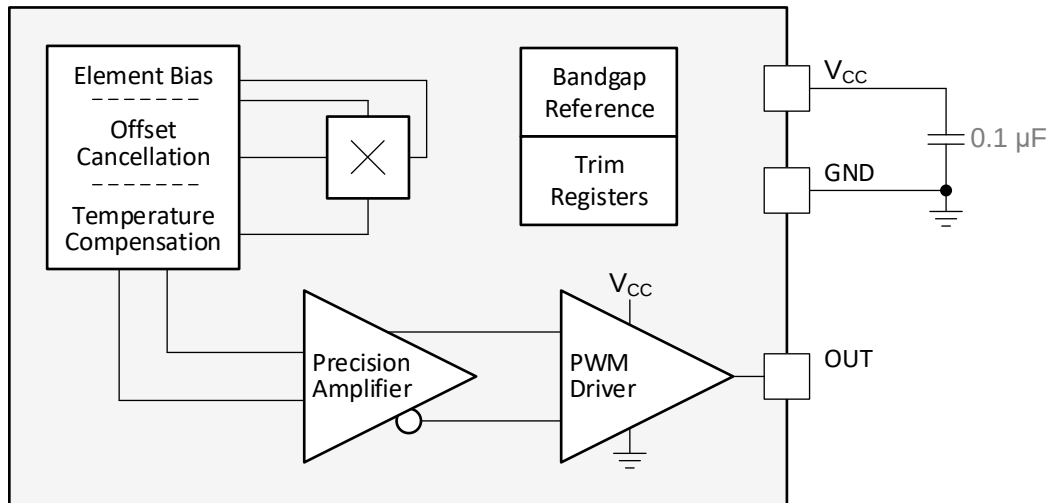
Figure 11. Sensitivity vs Temperature

7 Detailed Description

7.1 Overview

The DRV5057 is a 3-pin pulse-width modulation (PWM) output Hall effect sensor with fully integrated signal conditioning, temperature compensation circuits, mechanical stress cancellation, and amplifiers. The device operates from 3.3-V and 5-V ($\pm 10\%$) power supplies, measures magnetic flux density, and outputs a pulse-width modulated, 2-kHz digital signal.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 Magnetic Flux Direction

As shown in Figure 12, the DRV5057 is sensitive to the magnetic field component that is perpendicular to the top of the package.

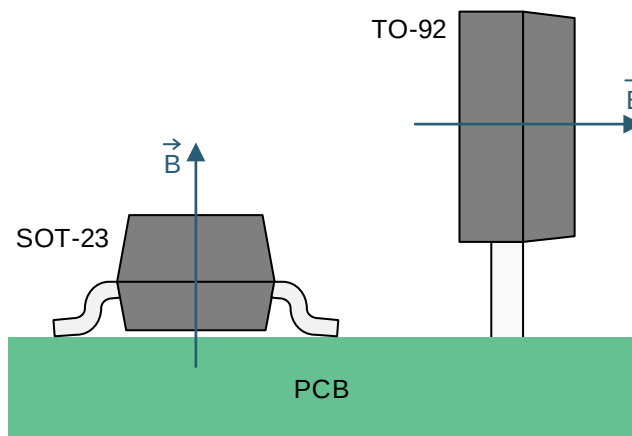


Figure 12. Direction of Sensitivity

Feature Description (continued)

Magnetic flux that travels from the bottom to the top of the package is considered positive in this document. This condition exists when a south magnetic pole is near the top (marked-side) of the package. Magnetic flux that travels from the top to the bottom of the package results in negative millitesla values. [Figure 13](#) shows flux direction.

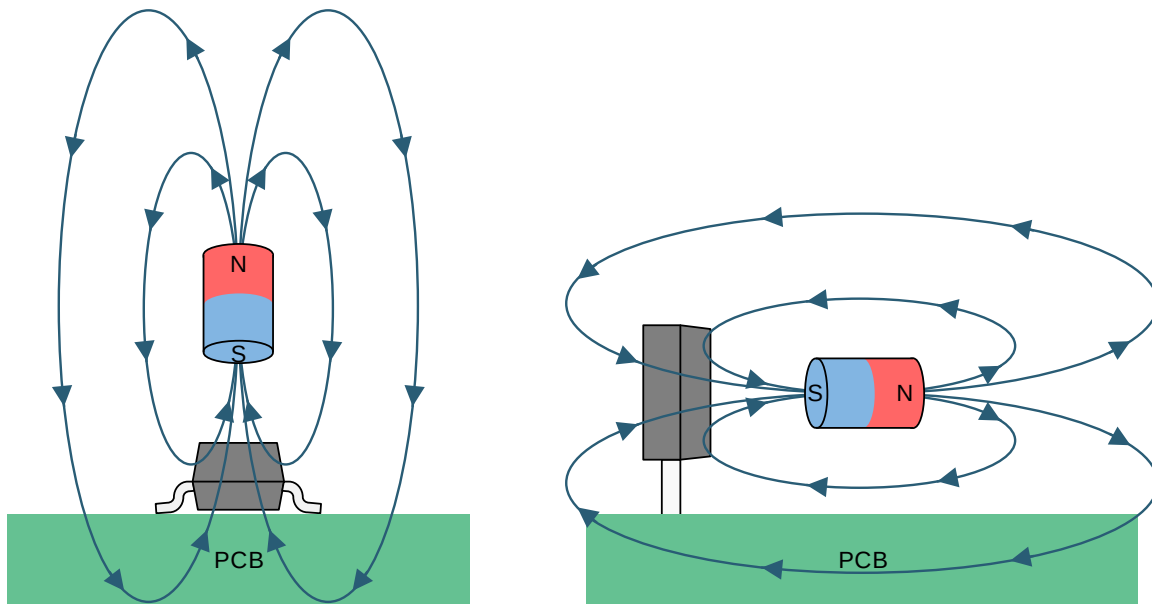


Figure 13. Flux Direction for Positive B

7.3.2 Sensitivity Linearity

The device produces a pulse-width modulated digital signal output. As shown in [Figure 14](#), the duty-cycle of the PWM output signal is proportional to the magnetic field detected by the Hall element of the device. If there is no magnetic field present, the duty cycle is 50%. The DRV5057 can detect both magnetic north and south poles. The output duty cycle maintains a linear relationship with the input magnetic field from 8% to 92%.

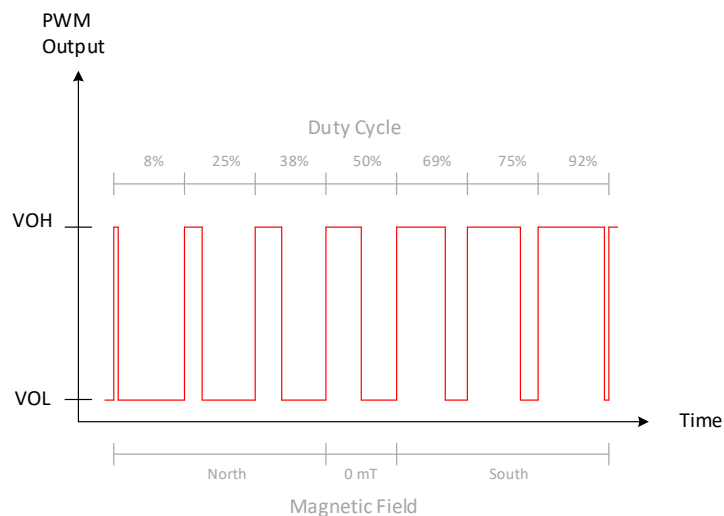


Figure 14. Magnetic Response

Feature Description (continued)

7.3.3 Operating V_{CC} Ranges

The DRV5057 has two recommended operating V_{CC} ranges: 3 V to 3.63 V and 4.5 V to 5.5 V. When V_{CC} is in the middle region between 3.63 V to 4.5 V, the device continues to function but sensitivity is less known because there is a crossover threshold near 4 V that adjusts device characteristics.

7.3.4 Sensitivity Temperature Compensation for Magnets

Magnets generally produce weaker fields as temperature increases. The DRV5057 has a temperature compensation feature that is designed to directly compensate the average drift of neodymium (NdFeB) magnets and partially compensate ferrite magnets. The residual induction (B_r) of a magnet typically reduces by 0.12%/°C for NdFeB, and 0.20%/°C for ferrite. When the operating temperature of a system is reduced, temperature drift errors are also reduced.

7.3.5 Power-On Time

After the V_{CC} voltage is applied, the DRV5057 requires a short initialization time before the output is set. The parameter t_{ON} describes the time from when V_{CC} crosses 3 V until OUT is within 5% of V_Q , with 0 mT applied and no load attached to OUT. Figure 15 shows this timing diagram.

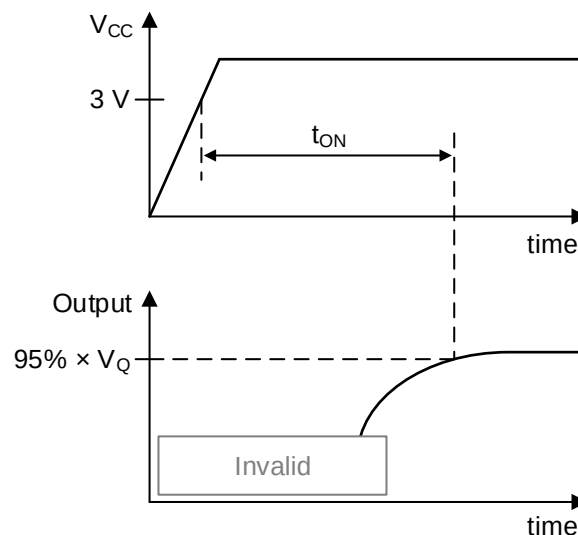


Figure 15. t_{ON} Definition

Feature Description (continued)

7.3.6 Hall Element Location

Figure 16 shows the location of the sensing element inside each package option.

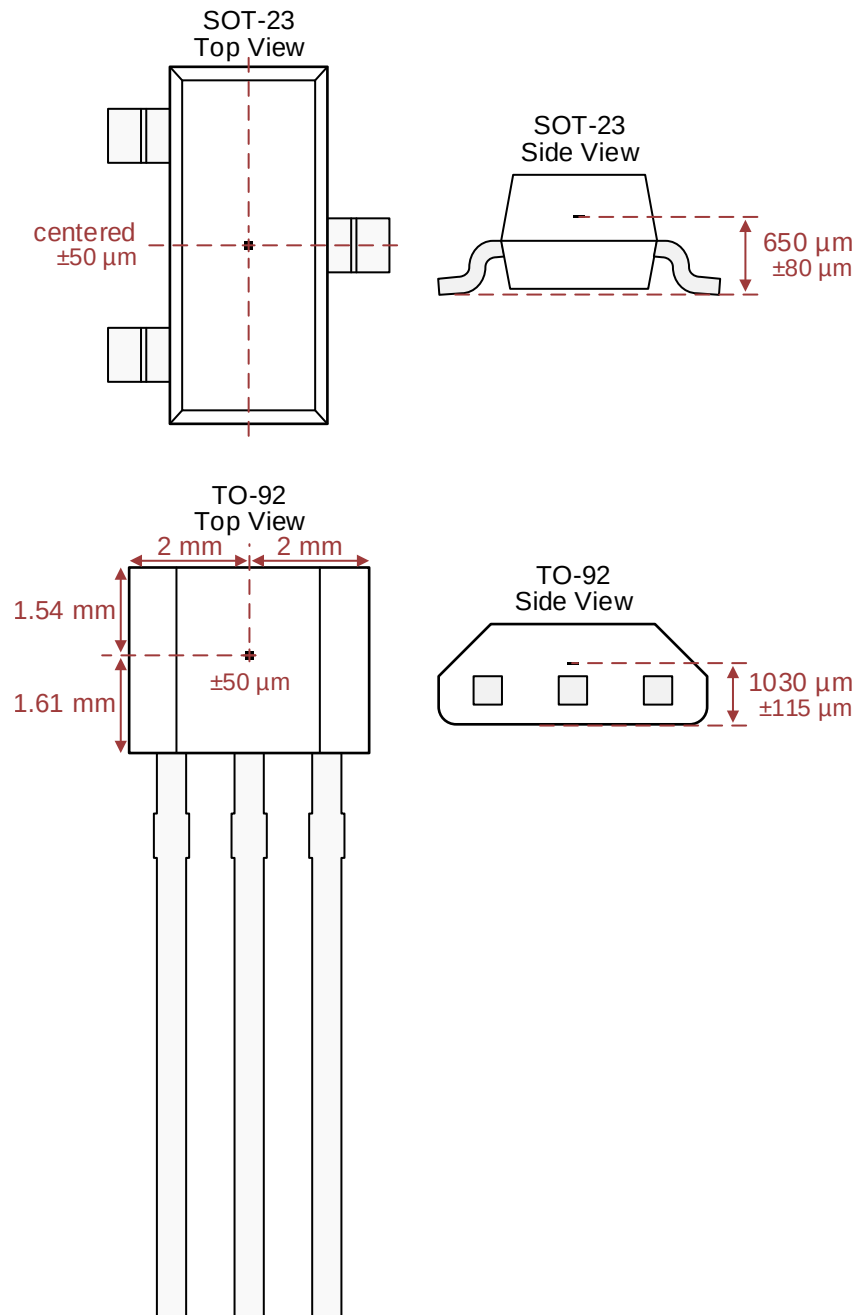


Figure 16. Hall Element Location

7.4 Device Functional Modes

The DRV5057 has one mode of operation that applies when the *Recommended Operating Conditions* are met.

8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

8.1.1 Selecting the Sensitivity Option

Select the highest DRV5057 sensitivity option that can measure the required range of magnetic flux density so that the output voltage swing is maximized.

Larger-sized magnets and farther sensing distances can generally enable better positional accuracy than very small magnets at close distances, because magnetic flux density increases exponentially with the proximity to a magnet. TI created an online tool to help with simple magnet calculations on the [DRV5057 product folder](#).

8.1.2 Decoding a PWM

8.1.2.1 Decoding a PWM (Digital)

8.1.2.1.1 Capture/Compare Timer Interrupt

Many microcontrollers have a capture/compare timer mode that can simplify the PWM decoding process. Use the timer in capture/compare mode with an interrupt that triggers on both the rising and falling edges of the signal to obtain both the relative high (on) and low (off) time of the PWM. Make sure that the timer period is significantly faster than the period of the PWM, based on the desired resolution. Calculate the percent duty cycle (%D) of the PWM with [Equation 1](#) by using the relative on and off time of the signal.

$$\%D = \frac{\text{OnTime}}{\text{OnTime} + \text{OffTime}} \times 100 \quad (1)$$

8.1.2.1.2 Oversampling and Counting With a Timer Interrupt

If a capture/compare timer is not available, a standard timer interrupt and a counter can be used. Configure the timer interrupt to be significantly faster than the period of the PWM, based on the desired resolution. Count how many times the timer interrupts while the signal is high (OnTime), then count how many times the timer interrupts while the signal is low (OffTime). Then use [Equation 1](#) to calculate the duty cycle.

8.1.2.1.3 Accuracy and Resolution

The accuracy and resolution for the methods described in the [Capture/Compare Timer Interrupt](#) and [Oversampling and Counting With a Timer Interrupt](#) sections depends significantly on the timer sampling frequency. [Equation 2](#) calculates the least significant bit of the duty cycle (%D_{LSB}) based on the chosen timer sampling frequency.

$$\%D_{\text{LSB}} = \frac{\text{PWM}_{\text{frequency}}}{\text{TIMER}_{\text{frequency}}} \times 100 \quad (2)$$

For example, with a 2-kHz PWM and a 400-kHz sampling frequency, the %D_{LSB} is (2 kHz / 400 kHz) × 100 = 0.5%D_{LSB}. If the sampling frequency is increased to 2-MHz, the %D_{LSB} is improved to be (2 MHz / 400 kHz) × 100 = 0.1%D_{LSB}. However, this accuracy and resolution is still subject to noise and sensitivity.

Application Information (continued)

8.1.2.2 Decoding a PWM (Analog)

If an analog signal is needed at the end of a large travel distance, first use a microcontroller to digitally decode the PWM, then use a DAC to produce the analog signal. If an analog signal is needed after a short signal travel distance, use an analog output device, such as the [DRV5055](#).

The PWM signal can be converted into an analog voltage by using a low-pass filter such as the one in [Figure 17](#) if a an analog signal is needed at the end of a large travel distance and a microcontroller is unavailable. If using this method, then:

- A ripple appears at the analog voltage output, causing a decrease in accuracy. The ripple intensity and frequency depend on the values chosen for R and C in the filter.
- The minimum and maximum voltages of the PWM must be known for the magnetic field strength to be calculated from the analog voltage. Thus, if the signal is traveling a large distance then the minimum and maximum values must be either measured or buffered back to a known value.

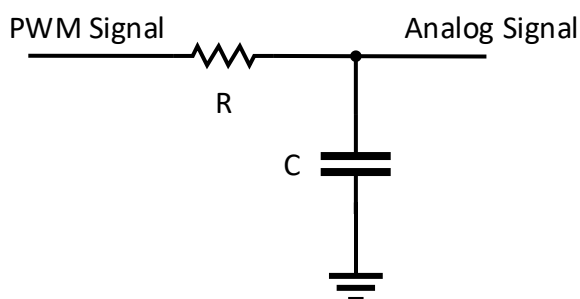


Figure 17. Low-Pass RC Filter

8.2 Typical Applications

8.2.1 Full Swing Example

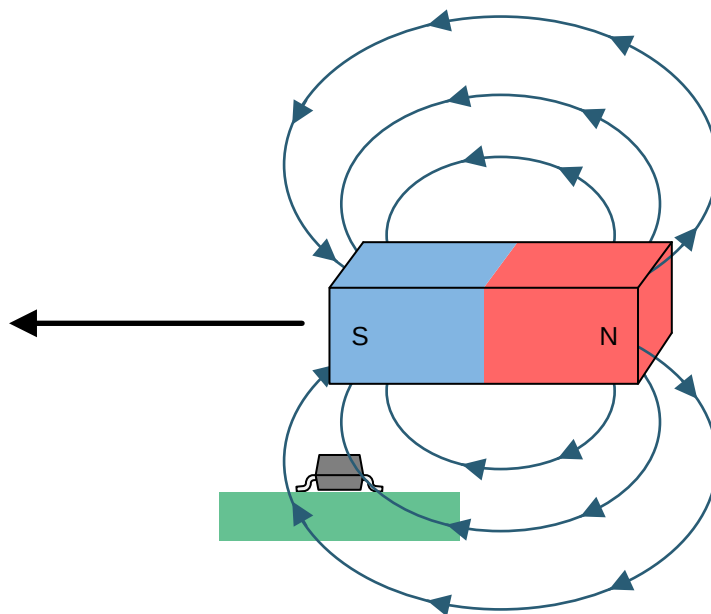


Figure 18. Common Magnet Orientation

Typical Applications (continued)

8.2.1.1 Design Requirements

Use the parameters listed in [Table 1](#) for this design example.

Table 1. Design Parameters

DESIGN PARAMETER	EXAMPLE VALUE
Device	DRV5057
V _{CC}	5 V
Magnet	Cylinder: 4.7625-mm diameter, 12.7-mm thick, neodymium N52, Br = 1480 mT
Travel distance	10 mm
Desired accuracy	< 0.1 mm

8.2.1.2 Detailed Design Procedure

Linear Hall effect sensors provide flexibility in mechanical design because many possible magnet orientations and movements produce a usable response from the sensor. [Figure 18](#) illustrates one of the most common orientations that uses the full north to south range of the sensor and causes a close-to-linear change in magnetic flux density as the magnet moves across the sensor. [Figure 19](#) illustrates the close-to-linear change in magnetic field present at the sensor as the magnet moves a given distance across the sensor. The usable linear region is close to but less than the length (thickness) of the magnet.

When designing a linear magnetic sensing system, always consider these three variables: the magnet, sensing distance, and the range of the sensor. Select the DRV5057 with the highest sensitivity possible based on the system distance requirements without railing the sensor PWM output. To determine the magnetic flux density the sensor receives at the various positions of the magnet, TI recommends using a magnetic field calculator or simulation software, referring to magnet specifications, and testing.

Determine if the desired accuracy is met by comparing the maximum allowed duty cycle least significant bit (%D_{LSBmax}) with the noise level (PWM jitter) of the device. [Equation 3](#) calculates the %D_{LSBmax} by taking into account the used length of the linear region (travel distance), the desired resolution, and the output PWM swing (within the linear duty cycle range).

$$\%D_{LSBmax} = \frac{\%D_{swing}}{\text{Travel Distance}} \times \text{Resolution} \quad (3)$$

Thus, with this example (and a linear duty cycle range of 8%D to 92%D), using [Equation 3](#) gives (92 – 8) / (10) × 0.1 = 0.84%D_{LSBmax}. This value is larger than the 0.1%D jitter, and therefore the desired accuracy can be achieved by using [Equation 2](#) to select a %D_{LSB} that is equal to or less than 0.84. Then, simply calibrate the magnet position to align the sensor output along the movement path.

8.2.1.3 Application Curve

Figure 19 shows the magnetic field present at the sensor as the magnet passes by as described in Figure 18. The change in distance from the trough to the peak is approximately the length (thickness) of the magnet. B changes based on the strength of the magnet and how close the magnet is to the sensor.

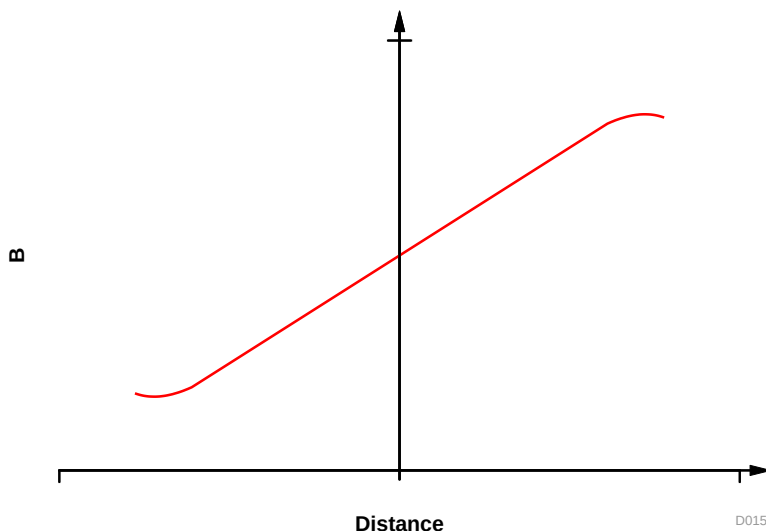


Figure 19. Magnetic Field vs Distance

8.2.2 Half Swing Example

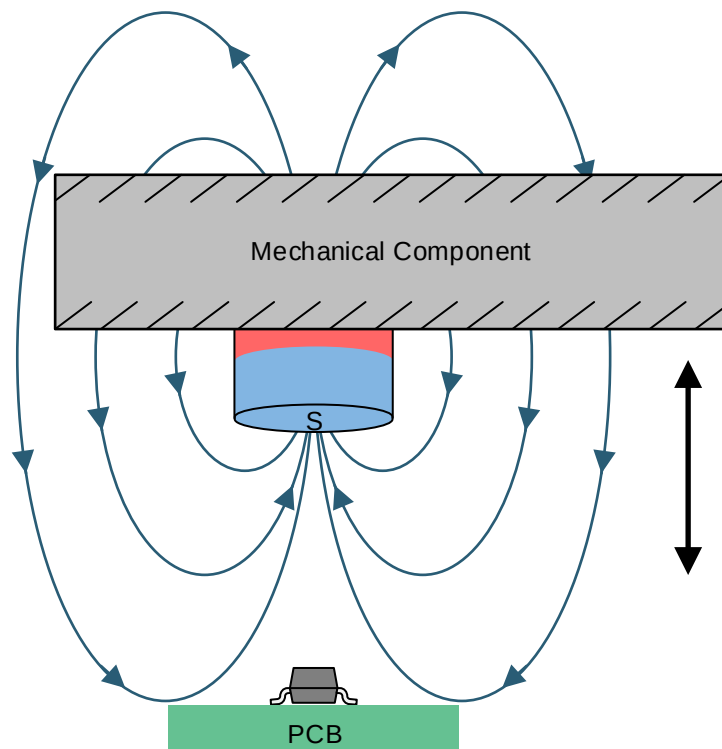


Figure 20. Physical Setup

8.2.2.1 Design Requirements

Use the parameters listed in [Table 2](#) for this design example.

Table 2. Design Parameters

DESIGN PARAMETER	EXAMPLE VALUE
Device	DRV5057
V _{CC}	5 V
Magnet	Cylinder: 4.7625 mm diameter, 12.7 mm thick, Neodymium N52, Br = 1480 mT
Travel distance	5 mm
Desired Accuracy	<0.1 mm

8.2.2.2 Detailed Design Procedure

As illustrated in [Figure 20](#), this design example consists of a mechanical component that moves back and forth, an embedded magnet with the south pole facing the printed-circuit board, and a DRV5057. The DRV5057 outputs a PWM that describes the precise position of the component. The component must not contain ferromagnetic materials such as iron, nickel, and cobalt because these materials change the magnetic flux density at the sensor.

When designing a linear magnetic sensing system, always consider these three variables: the magnet, sensing distance, and the range of the sensor. Select the DRV5057 with the highest sensitivity possible based on the system distance requirements without railing the sensor PWM output. To determine the magnetic flux density the sensor receives at the various positions of the magnet, TI recommends using a magnetic field calculator or simulation software, referring to magnet specifications, and testing.

Magnets are made from various ferromagnetic materials that have tradeoffs in cost, drift with temperature, absolute maximum temperature ratings, remanence or residual induction (B_r), and coercivity (H_c). The B_r and the dimensions of a magnet determine the magnetic flux density (B) produced in 3-dimensional space. For simple magnet shapes, such as rectangular blocks and cylinders, there are simple equations that solve B at a given distance centered with the magnet. [Figure 21](#) shows diagrams for [Equation 4](#) and [Equation 5](#).

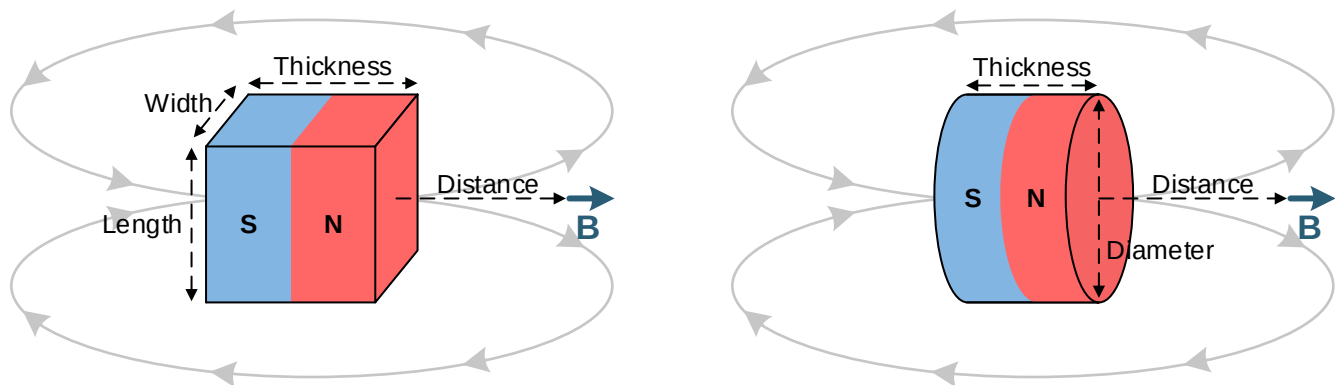


Figure 21. Rectangular Block and Cylinder Magnets

Use [Equation 4](#) for the rectangular block shown in [Figure 21](#):

$$\vec{B} = \frac{B_r}{\pi} \left(\arctan \left(\frac{WL}{2D\sqrt{4D^2 + W^2 + L^2}} \right) - \arctan \left(\frac{WL}{2(D+T)\sqrt{4(D+T)^2 + W^2 + L^2}} \right) \right) \quad (4)$$

Use Equation 5 for the cylinder illustrated in Figure 21:

$$\vec{B} = \frac{B_r}{2} \left(\frac{D + T}{\sqrt{(0.5C)^2 + (D + T)^2}} - \frac{D}{\sqrt{(0.5C)^2 + D^2}} \right)$$

where:

- W is width
- L is length
- T is thickness (the direction of magnetization)
- D is distance
- C is diameter

(5)

Because this example uses a cylinder magnet, Equation 5 can be used to create a lookup table for the distances from a specific magnet based on a magnetic field strength. Figure 22 shows a magnetic field from 0 mm to 16 mm with the magnet defined in Table 2 as C = 4.7625 mm, T = 12.7 mm, and B_r = 1480 mT.

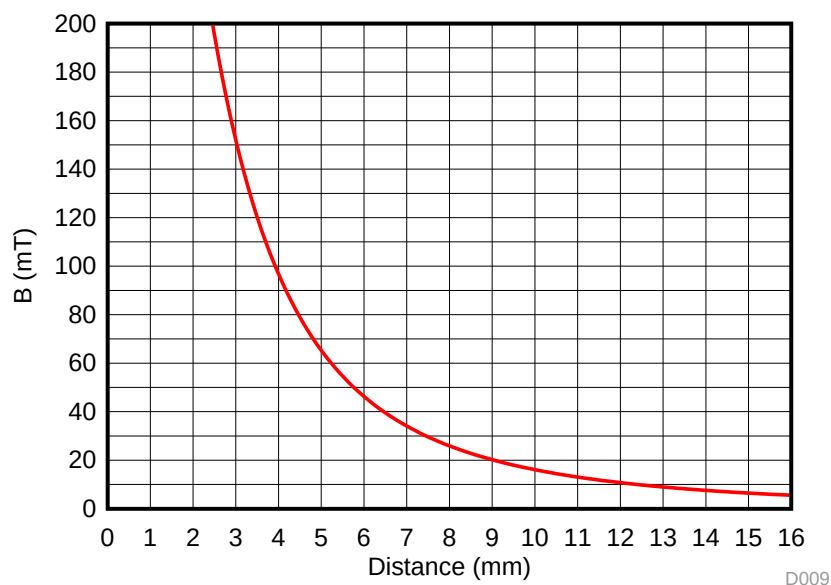


Figure 22. Magnetic Field vs Distance

In this setup, each gain version of the sensor produces the corresponding duty cycle shown in Figure 23 for 0 mm to 16 mm.

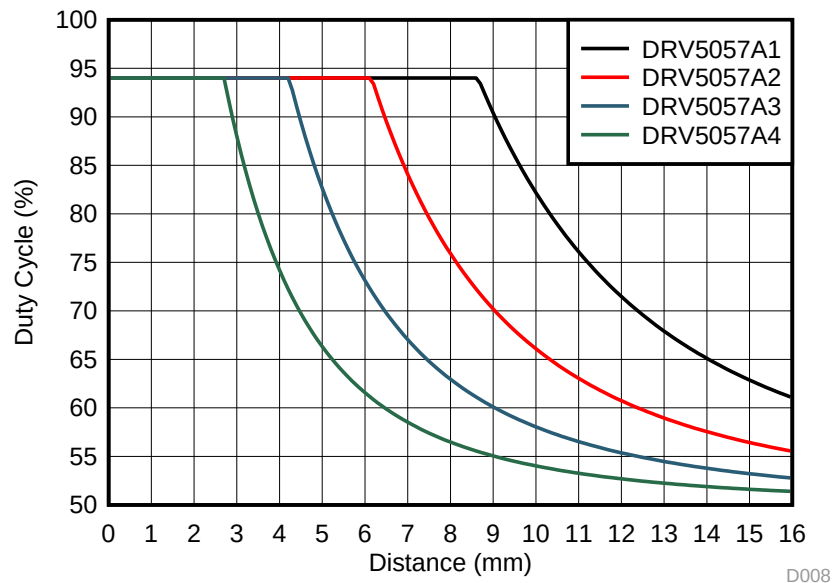


Figure 23. %D vs South Pole Distance (All Gains)

With a desired 5-mm movement swing, select the DRV5057 with the largest possible sensitivity that fits the system requirements for the magnet distance to the sensor. Assume that for this example, because of mechanical restrictions, the magnet at the nearest point to the sensor must be selected to be within 5 mm to 8 mm. The largest sensitivity option (A1) does not work in this situation because the device output is railed at the farthest allowed distance of 8 mm. The A2 version is not railed at this point, and is therefore the sensor selected for this example. Choose the closest point of the magnet to the sensor to be a distance that allows the magnet to get as close to the sensor as possible without railing but stays within the selectable 5-mm to 8-mm allowed range. Because the A2 version rails at approximately 6 mm, choose a closest distance of 6.5 mm to allow for a little bit of margin. With this choice, Figure 24 shows the %D response at the sensor across the full movement range.

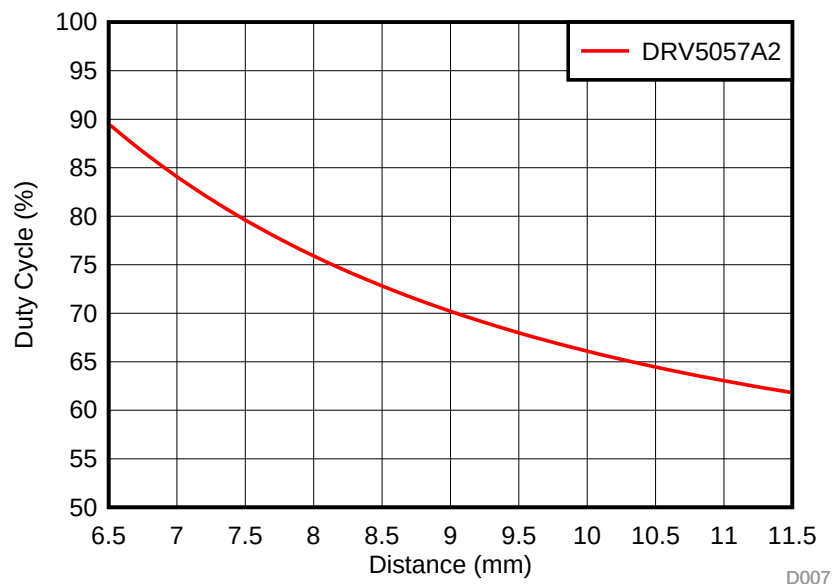


Figure 24. %D vs South Pole Distance (Gain A2)

The magnetic field strength is calculated using [Equation 6](#), where a negative number represents the opposite pole (in this example a south pole is over the sensor, causing the results to be a positive number).

$$B = \frac{(\%D - 50)}{\text{Gain}} \quad (6)$$

For example, if the A2 version of the DRV5057 measured a duty cycle using [Equation 1](#) of %D = 74.6%, then the magnetic field strength present at the sensor is (74.6 – 50) / 1 = 24.6 mT.

Using the lookup table that was used to create the plot in [Figure 22](#), the distance from the magnet at 24.6 mT is D ≈ 8.2 mm.

For more accurate results, the lookup table can be calibrated along the movement path of the magnet. Additionally, instead of using the calibrated lookup table for each measurement, consider using a best-fit polynomial equation from the curve for the desired movement range to calculate D in terms of B.

Because the curve in [Figure 24](#) is not linear, the achievable accuracy varies for each position along the movement path. The location with the worst accuracy is where there is the smallest change in output for a given amount of movement, which in this example is where the magnet is farthest from the sensor (at 11.5 mm). Determine if the desired accuracy is met by checking if the needed %D_{LSB} at this location for the specified accuracy is greater than the noise level (PWM jitter) of 0.1%D. Thus, with a desired accuracy of 0.1 mm, the needed %D_{LSB} is the change in %D between 11.4 mm and 11.5 mm. Using the lookup table to find B and then solving for %D in [Equation 6](#), at 11.5 mm B = 11.815 mT (which equates to 61.815%D) and at 11.4 mm B = 12.048 mT (which equates to 62.048%D). The difference in %D between these two points is 62.048 – 61.815 = 0.223%D_{LSB}. This value is larger than the 0.1%D jitter, so the desired accuracy can be met as long as a %D_{LSB} is selected that is equal to or less than 0.223 using [Equation 2](#).

8.3 What to Do and What Not to Do

Because the Hall element is sensitive to magnetic fields that are perpendicular to the top of the package, a correct magnet approach must be used for the sensor to detect the field. Figure 25 shows correct and incorrect approaches.

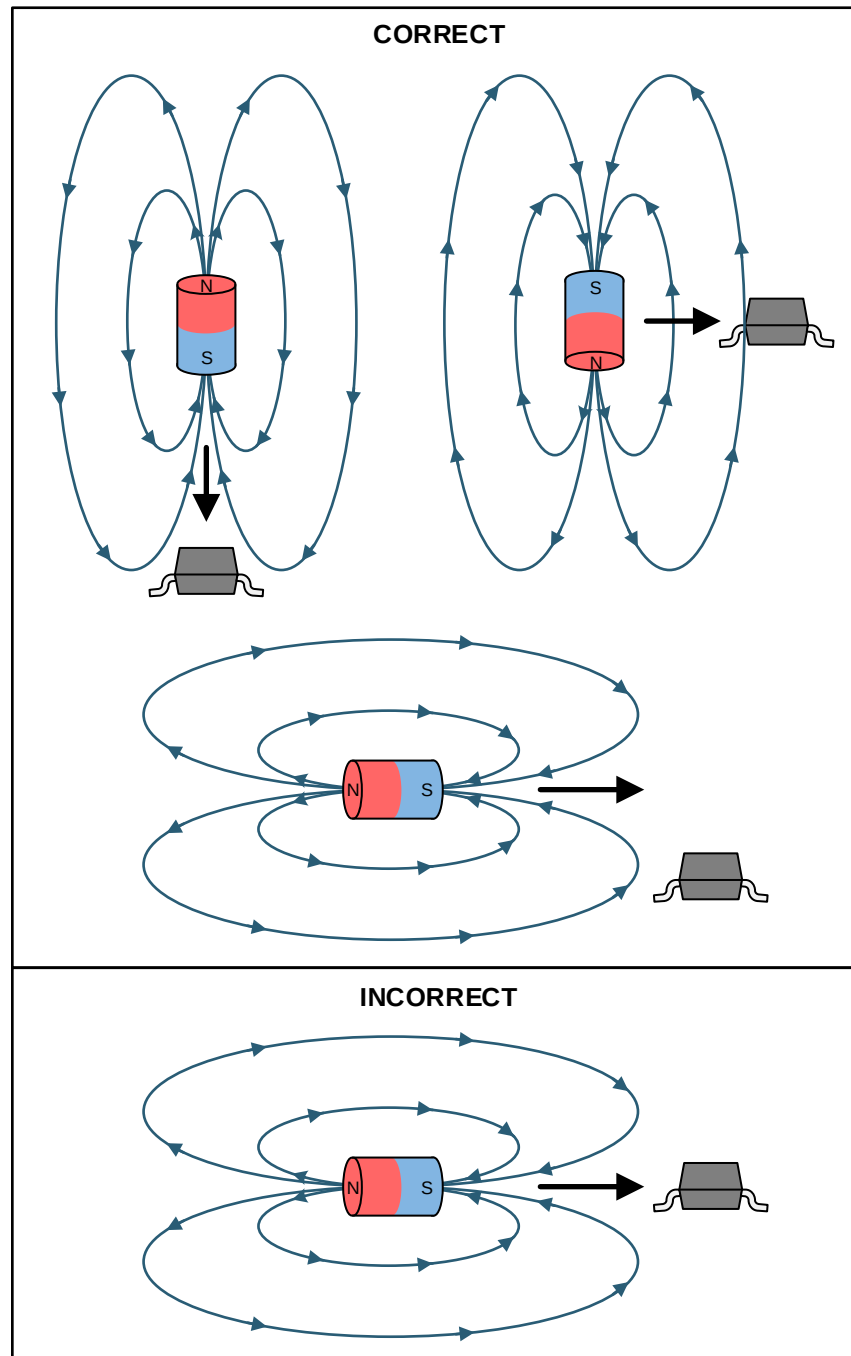


Figure 25. Correct and Incorrect Magnet Approaches

9 Power Supply Recommendations

A decoupling capacitor close to the device must be used to provide local energy with minimal inductance. TI recommends using a ceramic capacitor with a value of at least 0.01 μF .

10 Layout

10.1 Layout Guidelines

Magnetic fields pass through most nonferromagnetic materials with no significant disturbance. Embedding Hall effect sensors within plastic or aluminum enclosures and sensing magnets on the outside is common practice. Magnetic fields also easily pass through most printed-circuit boards, which makes placing the magnet on the opposite side possible.

10.2 Layout Examples

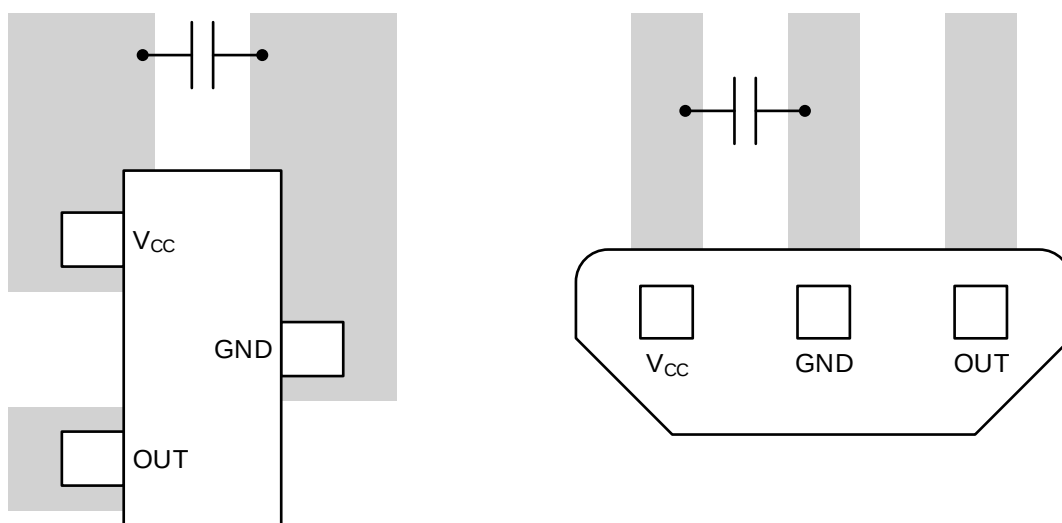


Figure 26. Layout Examples

11 Device and Documentation Support

11.1 Documentation Support

11.1.1 Related Documentation

For related documentation see the following:

- Texas Instruments, [Using Linear Hall Effect Sensors to Measure Angle tech note](#)
- Texas Instruments, [Incremental Rotary Encoder Design Considerations tech note](#)
- Texas Instruments, [DRV5055 Ratiometric Linear Hall Effect Sensor data sheet](#)

11.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

11.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

11.4 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

11.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

11.6 Glossary

SLYZ022 — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
DRV5057A1QDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	SN	Level-2-260C-1 YEAR	-40 to 125	57A1	Samples
DRV5057A1QDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	SN	Level-2-260C-1 YEAR	-40 to 125	57A1	Samples
DRV5057A1QLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	SN	N / A for Pkg Type	-40 to 125	57A1	Samples
DRV5057A1QLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	SN	N / A for Pkg Type	-40 to 125	57A1	Samples
DRV5057A2QDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	SN	Level-2-260C-1 YEAR	-40 to 125	57A2	Samples
DRV5057A2QDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	SN	Level-2-260C-1 YEAR	-40 to 125	57A2	Samples
DRV5057A2QLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	SN	N / A for Pkg Type	-40 to 125	57A2	Samples
DRV5057A2QLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	SN	N / A for Pkg Type	-40 to 125	57A2	Samples
DRV5057A3QDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	SN	Level-2-260C-1 YEAR	-40 to 125	57A3	Samples
DRV5057A3QDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	SN	Level-2-260C-1 YEAR	-40 to 125	57A3	Samples
DRV5057A3QLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	SN	N / A for Pkg Type	-40 to 125	57A3	Samples
DRV5057A3QLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	SN	N / A for Pkg Type	-40 to 125	57A3	Samples
DRV5057A4QDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	SN	Level-2-260C-1 YEAR	-40 to 125	57A4	Samples
DRV5057A4QDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	SN	Level-2-260C-1 YEAR	-40 to 125	57A4	Samples
DRV5057A4QLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	SN	N / A for Pkg Type	-40 to 125	57A4	Samples
DRV5057A4QLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	SN	N / A for Pkg Type	-40 to 125	57A4	Samples

⁽¹⁾ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of ≤ 1000 ppm threshold. Antimony trioxide based flame retardants must also meet the ≤ 1000 ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF DRV5057 :

- Automotive: [DRV5057-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects



PACKAGE OUTLINE

TO-92 - 5.05 mm max height

TRANSISTOR OUTLINE



1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

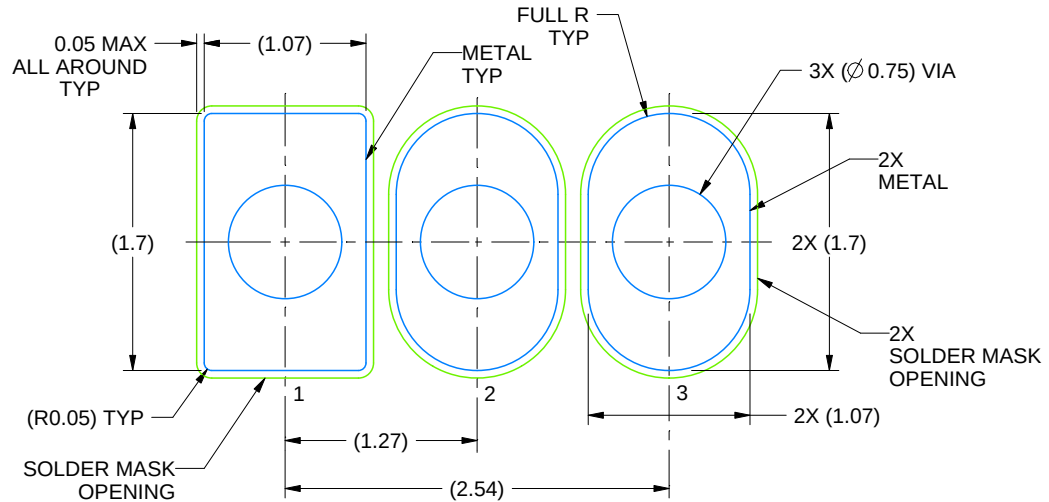
2. This drawing is subject to change without notice.

EXAMPLE BOARD LAYOUT

LPG0003A

TO-92 - 5.05 mm max height

TRANSISTOR OUTLINE



LAND PATTERN EXAMPLE
NON-SOLDER MASK DEFINED
SCALE:20X

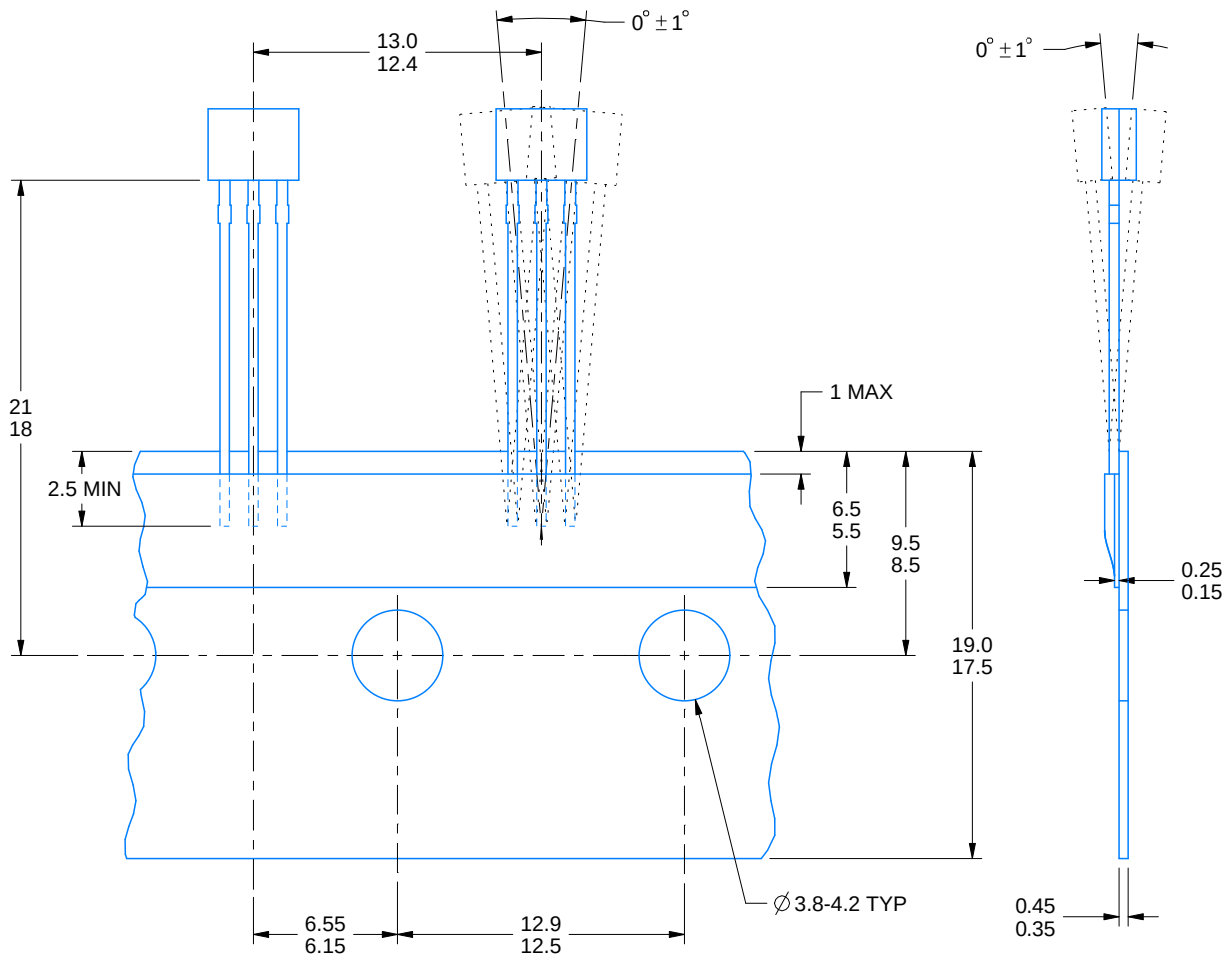
4221343/C 01/2018

TAPE SPECIFICATIONS

LPG0003A

TO-92 - 5.05 mm max height

TRANSISTOR OUTLINE



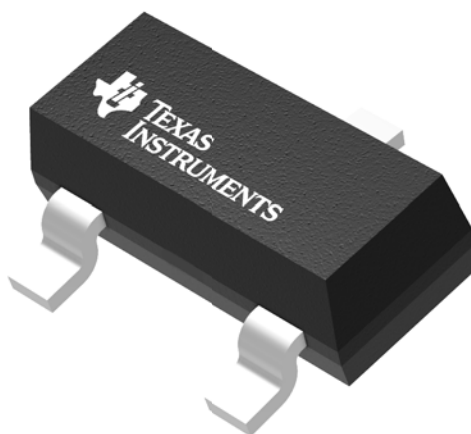
4221343/C 01/2018

GENERIC PACKAGE VIEW

DBZ 3

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4203227/C

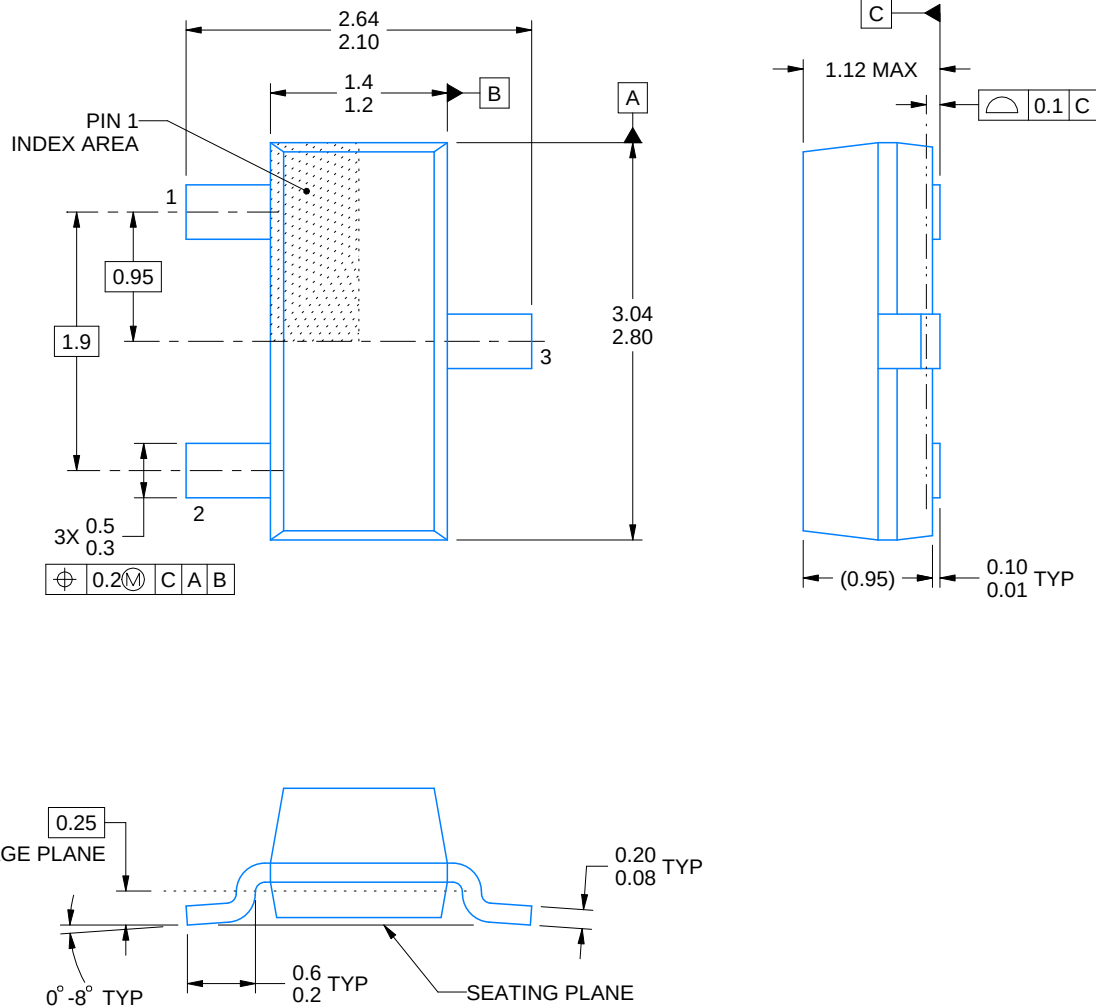
DBZ0003A



PACKAGE OUTLINE

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



4214838/C 04/2017

NOTES:

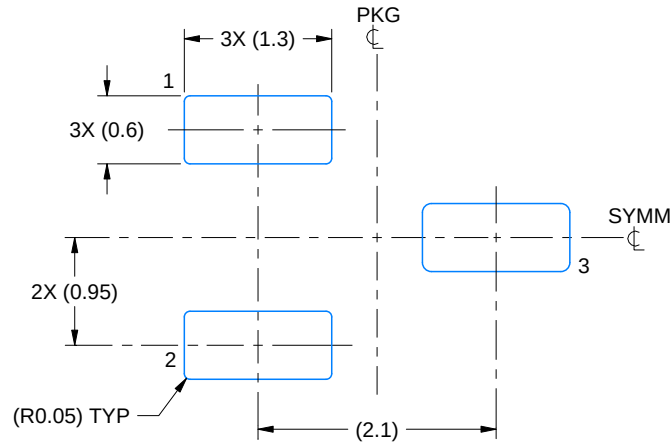
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC registration TO-236, except minimum foot length.

EXAMPLE BOARD LAYOUT

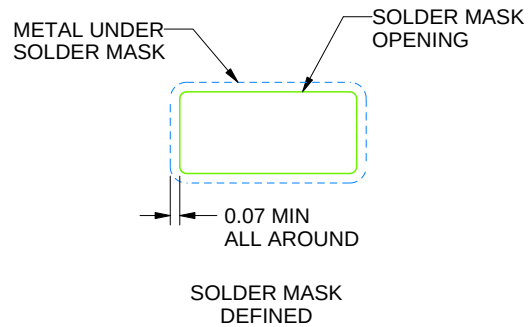
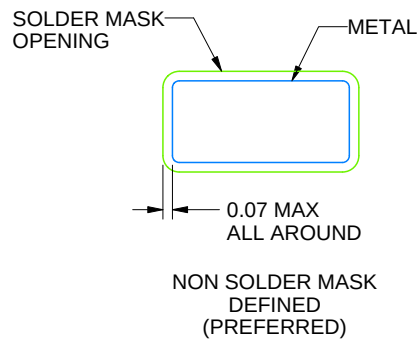
DBZ0003A

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
SCALE:15X



SOLDER MASK DETAILS

4214838/C 04/2017

NOTES: (continued)

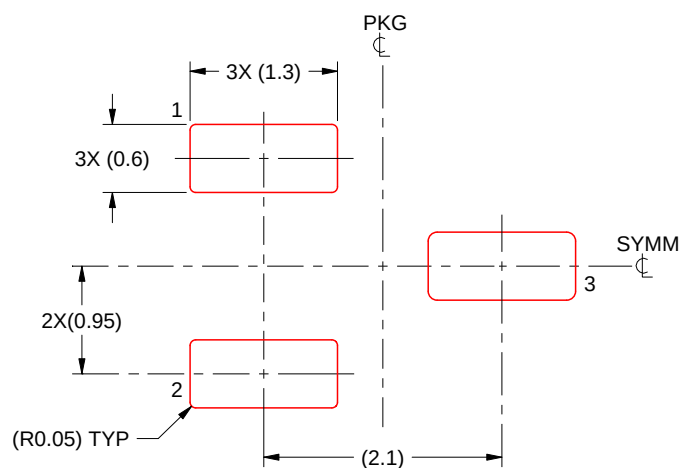
4. Publication IPC-7351 may have alternate designs.
5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DBZ0003A

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE
BASED ON 0.125 THICK STENCIL
SCALE:15X

4214838/C 04/2017

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
7. Board assembly site may have different recommendations for stencil design.

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